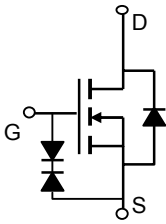
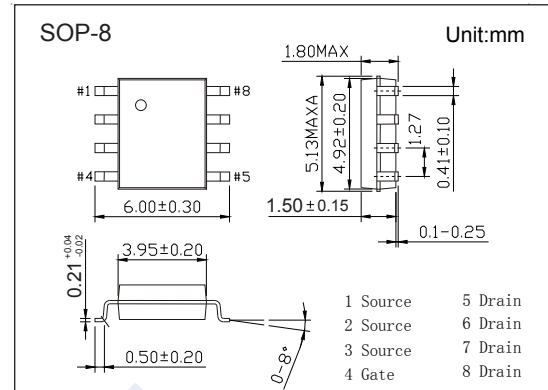


## N-Channel MOSFET

### AO4490 (KO4490)

#### ■ Features

- $V_{DS} (V) = 30V$
- $I_D = 16 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 7.2m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 10m\Omega (V_{GS} = 4.5V)$
- ESD Rating: 2KV HBM



#### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	$V_{DS}$	30	V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$		
Continuous Drain Current	$I_D$	$T_A=25^\circ C$	16	A
		$T_A=70^\circ C$	13	
Pulsed Drain Current	$I_{DM}$	120		
Avalanche Current	$I_{AR}$	30		
Repetitive Avalanche Energy	$L=0.3mH$	$E_{AR}$	135	mJ
Power Dissipation	$P_D$	$T_A=25^\circ C$	2.8	W
		$T_A=70^\circ C$	1.8	
Thermal Resistance.Junction- to-Ambient	$R_{thJA}$	$t \leq 10s$	45	$^\circ C/W$
		Steady-State	75	
Thermal Resistance.Junction- to-Lead	$R_{thJL}$	24		
Junction Temperature	$T_J$	150	$^\circ C$	
Storage Temperature Range	$T_{stg}$	-55 to 150		

## N-Channel MOSFET

## AO4490 (KO4490)

## ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	I <sub>D</sub> =250 μA, V <sub>GS</sub> =0V	30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
		V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			5	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±16V			±10	μA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.4		2.5	V
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =16A			7.2	mΩ
		V <sub>GS</sub> =10V, I <sub>D</sub> =16A, T <sub>J</sub> =125°C			10	
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =12A			10	
On State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =5V	120			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =16A		55		S
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1MHz		1803	2170	pF
Output Capacitance	C <sub>oss</sub>			387		
Reverse Transfer Capacitance	C <sub>rss</sub>			238		
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		1.3	2	Ω
Total Gate Charge (10V)	Q <sub>g</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =16A		36	48	nC
Total Gate Charge (4.5V)				19		
Gate Source Charge	Q <sub>gs</sub>			3.9		
Gate Drain Charge	Q <sub>gd</sub>			8.7		
Turn-On DelayTime	t <sub>d(on)</sub>		V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, R <sub>L</sub> =1Ω, R <sub>GEN</sub> =3Ω		7.6	
Turn-On Rise Time	t <sub>r</sub>			6.4		
Turn-Off DelayTime	t <sub>d(off)</sub>			27		
Turn-Off Fall Time	t <sub>f</sub>			8.5		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 16A, di/dt= 100A/us		27	33	nC
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			17		
Maximum Body-Diode Continuous Current	I <sub>S</sub>				4	A
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1A, V <sub>GS</sub> =0V			1	V

Note : The static characteristics in Figures 1 to 6 are obtained using <300 us pulses, duty cycle 0.5% max.

## ■ Marking

Marking	4490
	KC****

## N-Channel MOSFET AO4490 (KO4490)

■ Typical Characteristics

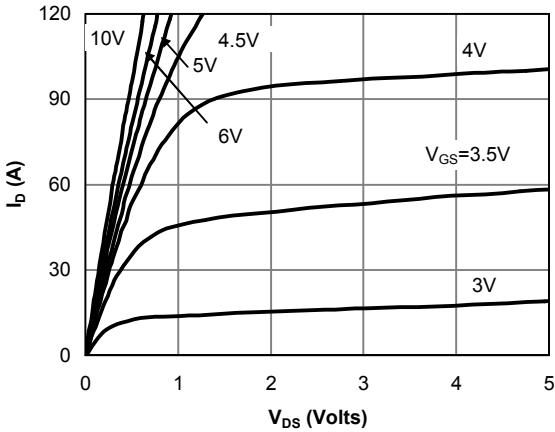


Figure 1: On-Region Characteristics

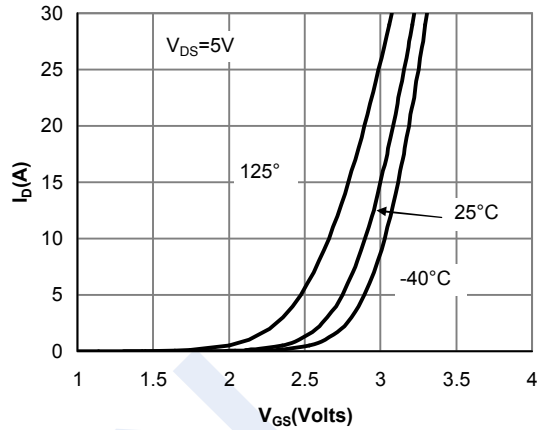


Figure 2: Transfer Characteristics

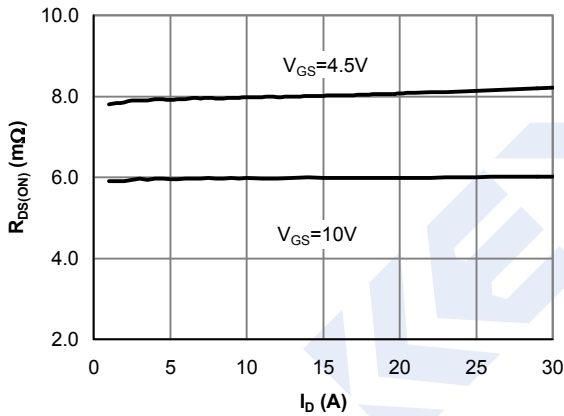


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

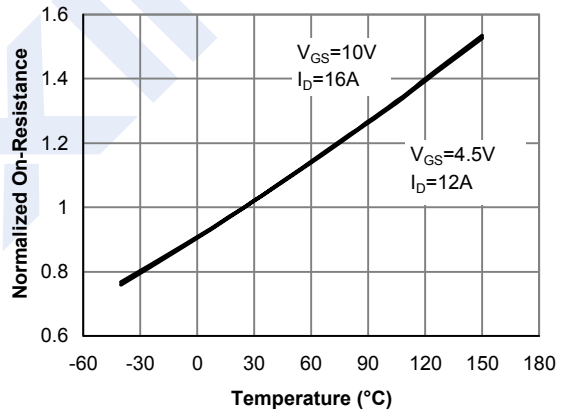


Figure 4: On-Resistance vs. Junction Temperature

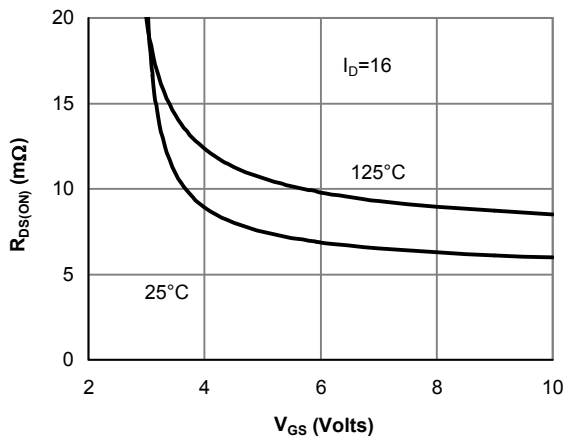


Figure 5: On-Resistance vs. Gate-Source Voltage

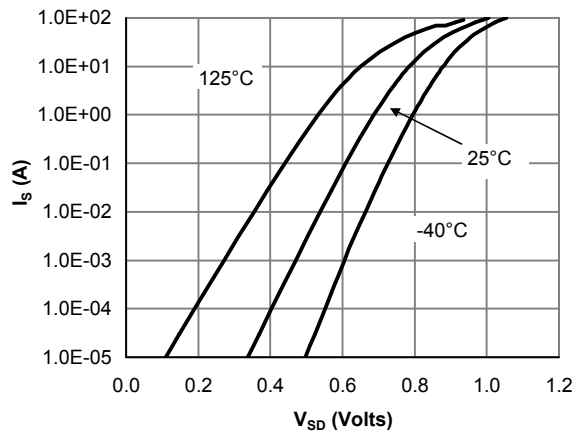


Figure 6: Body-Diode Characteristics

## N-Channel MOSFET AO4490 (KO4490)

■ Typical Characteristics

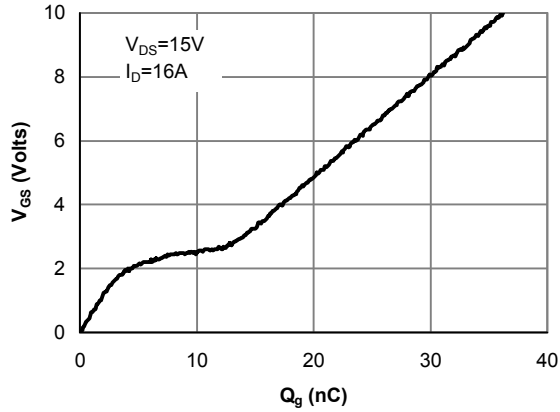


Figure 7: Gate-Charge Characteristics

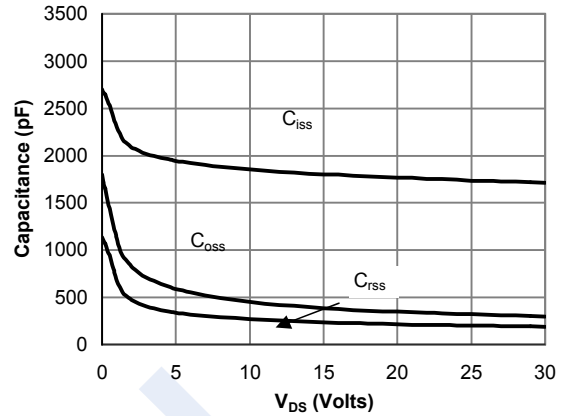


Figure 8: Capacitance Characteristics

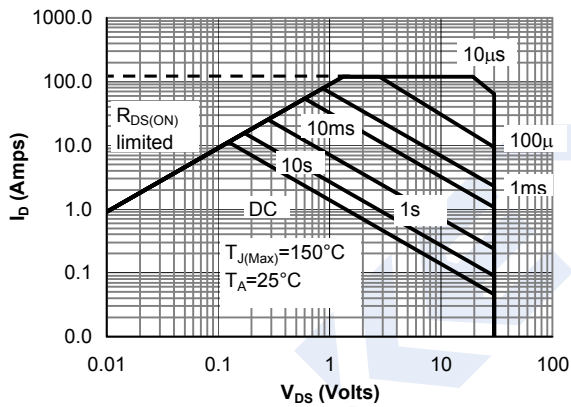


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

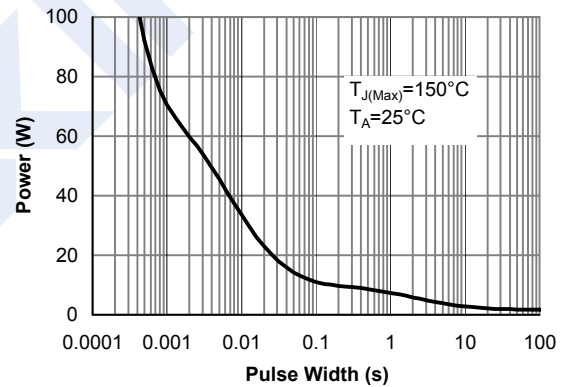


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

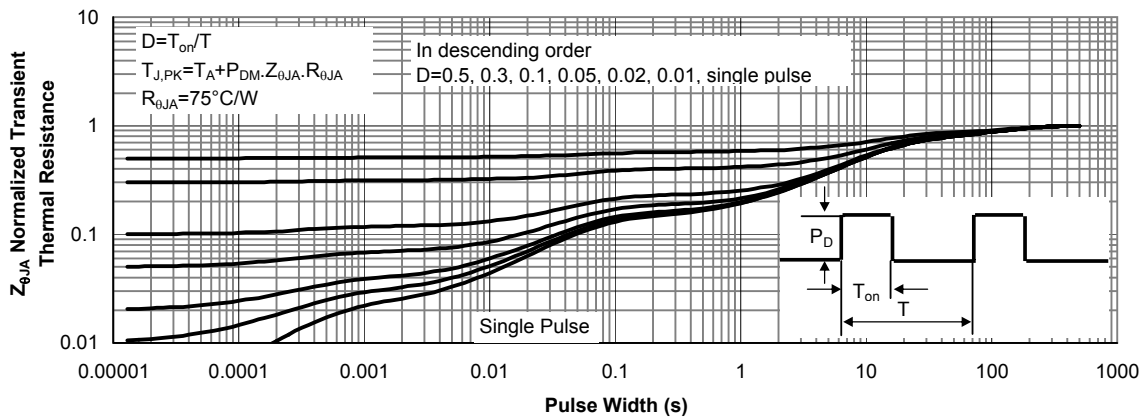


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)

## N-Channel MOSFET

### AO4490 (KO4490)

#### ■ Typical Characteristics

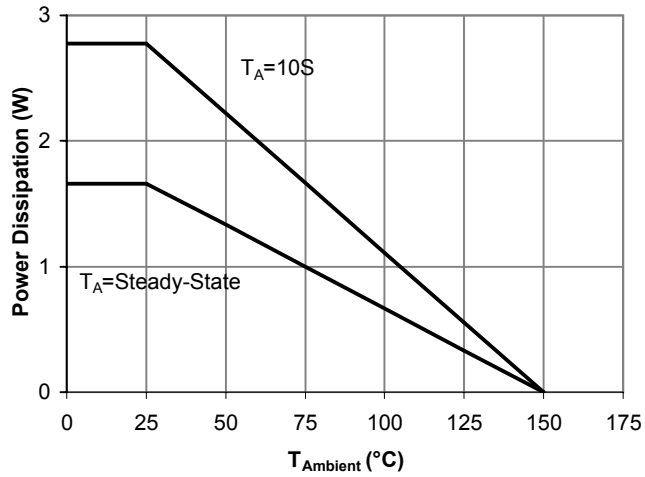


Figure 12: Power De-rating (Note A)